

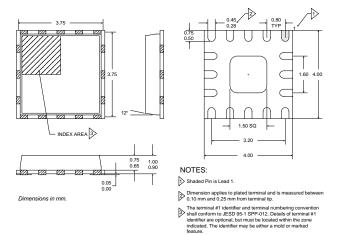
3V CDMA/FM MIXER

Typical Applications

- CDMA/FM Cellular Systems
- Supports Dual-Mode AMPS/CDMA
- Supports Dual-Mode TACS/CDMA
- General Purpose Downconverter
- Commercial and Consumer Systems
- Portable Battery-Powered Equipment

Product Description

The RF2466 is a receiver dual downconverter designed for the receive section of dual-mode CDMA/FM cellular applications. It is designed to downconvert RF signals while providing 14dB gain in CDMA mode and 7dB gain in FM mode. Also, it features IF output selection and power down mode. Noise Figure, IP3, and other specs are designed to be compatible with the IS-95 Interim Standard for CDMA cellular communications. The IC is manufactured on an advanced Silicon Bipolar process.



4 Pins 1 and 9 are fused.
5 Package Warpage: 0.05 max.

Package Style: LCC, 16-Pin, 4x4

Optimum Technology Matching® Applied

Si BJT
Si Bi-CMOS

☐ GaAs HBT ☐ SiGe HBT

☐ GaAs MESFET☐ Si CMOS

Functional Block Diagram

Features

- Dual Mode CDMA/AMPS
- Dual Mode JCDMA/TACS
- Digitally Selectable IF Outputs
- 500MHz to 1100MHz Operation
- Power Down Mode

Ordering Information

RF2466 3V CDMA/FM Mixer

RF2466 PCBA Fully Assembled Evaluation Board

RF Micro Devices, Inc. 7628 Thorndike Road Greensboro, NC 27409, USA Tel (336) 664 1233 Fax (336) 664 0454 http://www.rfmd.com

RF2466

Absolute Maximum Ratings

Parameter	Rating	Unit		
Supply Voltage	-0.5 to +5	V_{DC}		
Operating Ambient Temperature	-40 to +85	°C		
Storage Temperature	-40 to +150	°C		



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Parameter	Specification		Unit	Condition	
Parameter	Min.	Тур.	Max.	Unit	Condition
Overall					T=25° C, V _{CC} =3.0 V, RF=881 MHz, LO=966 MHz @ 0dBm, IF1= CDMA, IF2=FM
RF Frequency Range		200 to 1000		MHz	
LO Frequency Range		500 to 1100		MHz	
IF Frequency Range		0.1 to 250		MHz	
Conversion Gain	12.5	14		dB	IF1, 1k Ω balanced load.
	5	7		dB	IF2, 870 Ω load.
Noise Figure		9		dB	IF1 single sideband.
-		10.5		dB	IF2 single sideband
Input VSWR		<1.5:1			IF1 with external matching
		<2:1			IF2 with external matching
Input IP3	+3	+7		dBm	IF1
	+3	+7		dBm	IF2
Input P1dB		-7		dBm	IF1
		-4		dBm	IF2
MIX IN to IF1, IF2 Rejection		35		dB	
IF1, IF2 Output Freq. Range		70 to 100		MHz	With external IF interface network
Output Impedance		>1		kΩ	IF1, balanced, open collector
		870		Ω	IF2, single ended, with external inductor.
LO Input					
LO Input Range	-10	-3	0	dBm	
LO IN to RF Input Rejection		20		dB	
LO IN to IF1, IF2 Rejection		15		dB	
LO Input VSWR		<2:1			IF1 with external matching network
		2.5			IF2 with external matching network
Power Supply					
Voltage	2.7	3.0	4.0	V	
Current Consumption		16	21	mA	IF1 selected
		12	16	mA	IF2 selected
			5	μΑ	ENABLE=0

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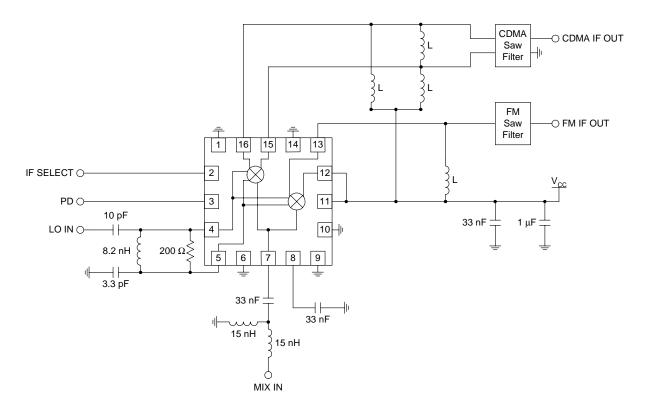
Pin	Function	Description	Interface Schematic
1	GND	Ground connection. For best performance, keep traces physically short and connect immediately to ground plane.	
2	IF SELECT	Control line for IF out select. A logic "low" enables the FM output. A logic "high" enables the CDMA output. The threshold voltage is 1.6 V, and the pin draws less than 50 µA when selected.	C1 Ο— ΛΛΛ— ►
3	PD	Power down pin. A logic "low" (<1.6V) turns the part off. A logic "high" (>1.6V) turns the part on. In addition, pin 2 (IF SELECT) should also be taken low during power down.	PD O—
4	LO+	Mixer LO balanced input pin. For single-ended input operation, this pin is used as an input and pin 5 is bypassed to ground.	LO IN-
5	LO-	Same as pin 4 except complementary input.	See pin 4.
6	GND	Ground connection for the mixer. For best performance, keep traces physically short and connect immediately to ground plane.	
7	MIXER IN	Mixer RF input pin. This pin is internally DC-biased and should be DC blocked if connected to a device with DC present. External matching network sets RF and IF impedance for optimum performance.	MIX IN O
8	BYPASS	Internal voltage reference. External RF and IF bypassing is required. The trace length between the pin and the bypass capacitors should be minimized. The ground side of the bypass capacitors should connect immediately to ground plane.	
9	GND	Same as pin 1.	
10	GND	Same as pin 1.	
11	VCC	Supply voltage for the mixers, bias circuits, and control logic. External RF and IF bypassing is required. The trace length between the pin and the bypass capacitors should be minimized. The ground side of the bypass capacitors should connect immediately to ground plane.	VCC2 BIAS CO OUT
12	FM-	Same as pin 13, except complimentary output. For typical single ended operation, this pin is connected directly to V_{CC} .	See pin 13.
13	FM+	FM IF output pin. This is a balanced output, but is typically used as a single-ended output. The internal circuitry, in conjunction with an external matching/bias inductor to V_{CC} , sets the operating impedance. This inductor is typically incorporated in the matching network between the output and IF filter. The net output impedance, including the external inductor, is about 870Ω at $85\text{MHz}.$ Because this pin is biased to V_{CC} , a DC blocking capacitor must be used if the IF filter input has a DC path to ground. See Application Schematic.	1F2+ 1F2- 0 8.5 pF 2.1 kΩ
14	GND	Same as pin 1.	
15	CDMA+	CDMA IF output pin. This is a balanced output. The internal circuitry, in conjunction with an external matching/bias inductor to V_{CC} , sets the operating impedance. This inductor is typically incorporated in the matching network between the output and IF filter. The net output impedance, including the external inductor, at 85 MHz is higher than $1k\Omega$, even though the part is designed to drive a $1k\Omega$ load. Because this pin is biased to V_{CC} , a DC blocking capacitor must be used if the IF filter input has a DC path to ground. See Application Schematic.	IF1+ GND2 IF1- 1.2 1.2 pF pF
16	CDMA-	Same as pin 15, except complementary output.	See pin 15.

RF2466

Pin	Function	Description	Interface Schematic
Pkg Base	GND	Ground connection. The backside of the package should be soldered to a top side ground pad which is connected to the ground plane with multiple vias.	

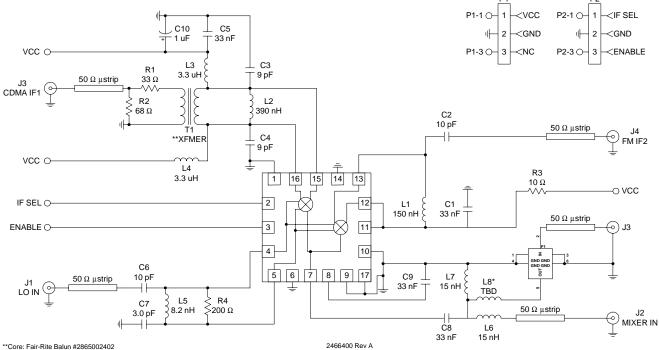
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Application Schematic



Evaluation Board Schematic

(Download Bill of Materials from www.rfmd.com.)



**Core: Fair-Rite Balun #2865002402

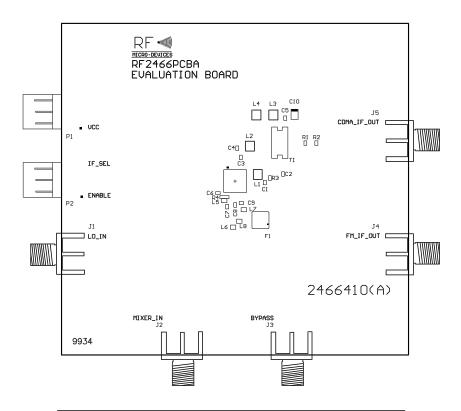
"Core: Fair-Nite Balun #2865002402
L12: 3 turns #30 AWG (Green)
L34: 12 turns #32 AWG (Red)
One turn = one pass through BOTH holes.
Winding starts and finishes on same end of core.
L12 and L34 exit opposite ends of core.
F1: filter

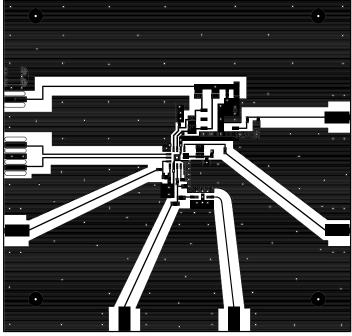
Enable	IF Select	Stage
0	0	Off
0	1	Off
1	0	FM
1	1	CDMA

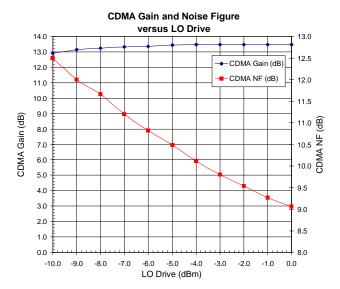
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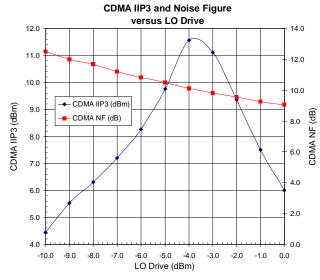
Evaluation Board Layout Board Size 3.070" x 2.928"

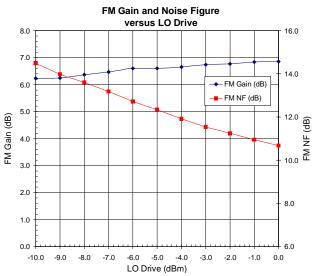
Board Thickness 0.056", Board Material FR-4, Multi-Layer

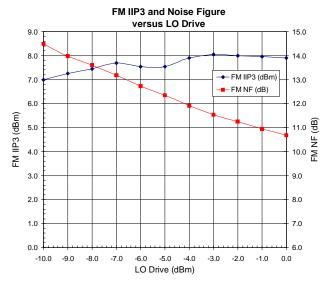












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